503566637 11/12/2015

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHYH-AN CHI	11/16/2010

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
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City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14939288

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NAME OF SUBMITTER:	RANDY A. NORANBROCK	
SIGNATURE:	/Randy A. Noranbrock/	
DATE SIGNED:	11/12/2015	

Total Attachments: 1

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PATENT 503566637 REEL: 037024 FRAME: 0486

Docket No. T5057-Y300

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

1) Shyh-An CHI

RECORDED: 11/12/2015

who has made a certain new and useful invention, hereby sells, assig	ns and transfers unto
TAIWAN SEMICONDUCTOR MANUFACTURING	
8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu 300	
its successors and assigns (hereinafter designated "ASSIGNEE") the eas defined in 35 U.S.C. 100 in the invention entitled	
PROCESSING UNIT WITH TIGHTLY COUPLED S	SMART MEMORY UNIT
(a) for which an application for United States Letters Patent was States Patent Application No. 12/947,177; or	filed on 11-16-10 , and identified by United
(b) for which an application for United States Letters Patent was	executed on,
and the undersigned hereby authorizes and requests the United States all United States Letters Patent which may be granted therefore and a continuations-in-part thereof, and the right to all benefits under the Property to the said ASSIGNEE, for its interest as ASSIGNEE, its su agrees that the attorneys of record in said application shall hereafter act AND the undersigned hereby agrees to transfer a like in application for and obtaining original, divisional, reissued or extended ASSIGNEE, its successors, assigns and legal representatives, and with applications for patent based thereon, growing out of or related to the ASSIGNEE, its successors, assigns and legal representatives, deemed the invention hereby transferred.	International Convention for the Protection of Industrial coessors, assigns and legal representatives; the undersigned on behalf of said ASSIGNEE; terest, and to render all necessary assistance in making Letters Patent of the United States, upon request of the said out further remuneration, in and to any improvements, and the said inventions are said inventions.
SIGNED on the date indicated aside my signature:	
Name: Shyh An CHI	Date:
2)	
Name:	Date:
3)	
Name:	Date:

PATENT REEL: 037024 FRAME: 0487